



You are invited to join us for an [IEEE virtual volunteer panel](#) hosted by IEEE on Wednesday **21 June 2023 at 2:00-3:00 pm EDT**. Please note that this is the rescheduled event that you previously registered for. You will need to register again to attend the rescheduled event.

Our panelists of IEEE members engaged with the semiconductor industry will discuss opportunities for IEEE to engage with global CHIPS initiatives. The conversation will be moderated by IEEE President-Elect Tom Coughlin. Panelists include:

- Bill Chen
- Matt Francis
- Kathy Herring Hayashi
- Kathleen Kramer
- Rakesh Kumar
- Tim Lee
- Dejan Milojevic
- Jeewika Ranaweera

Our panel of volunteers will discuss potential opportunities, and we will invite any interested members to offer their thoughts on the discussion via chat as well. Please note that this invitation is exclusively for IEEE members.

As part of this event, we will be asking panelists the following questions:

- What opportunities are there for IEEE related to CHIPS? What should we be doing globally? Regionally?
- Are there revenue opportunities for IEEE?
- How can we create opportunities to build a more diverse engineering workforce and create more economic opportunities in communities that are often overlooked?
- What opportunities do we have for cross-OU collaboration?
- Are there non-IEEE entities that we should consider partnering with in this work?

- How can IEEE have a positive impact on CHIPS initiatives globally? How do we engage here in the spirit of our mission to advance technology for humanity?

We would welcome your participation in this event. You can [RSVP here](#).

Please note that you will need to register again for the new date, even if you registered previously.

We hope that you will be able to participate in this event. Your input will be valuable as IEEE seeks to engage meaningfully in CHIPS activities while fulfilling our mission to advance technology for humanity.